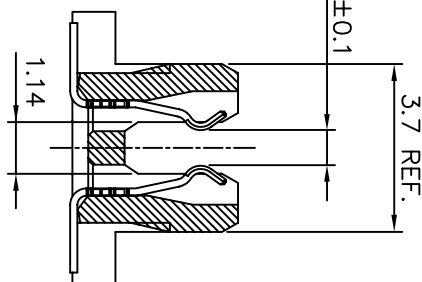
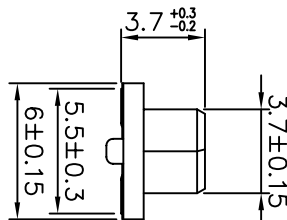
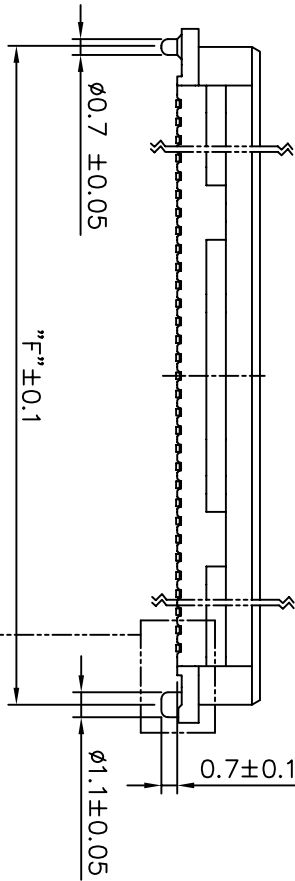
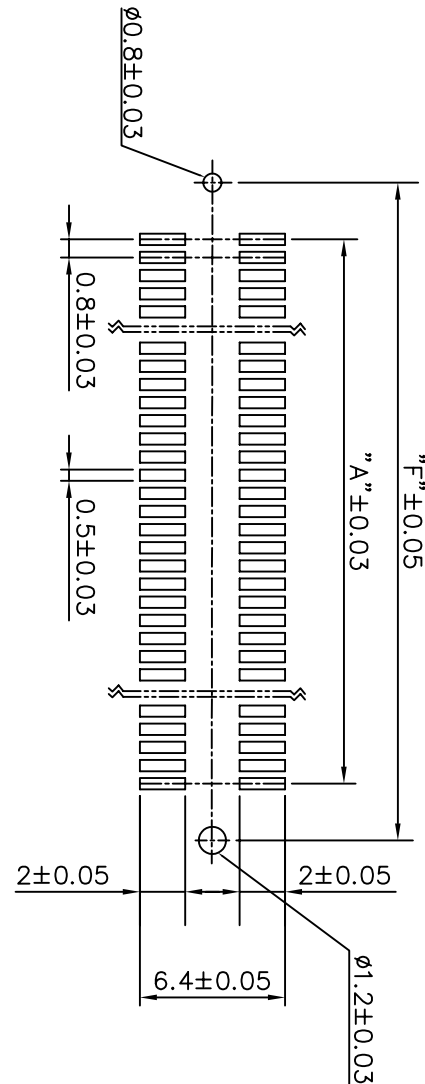
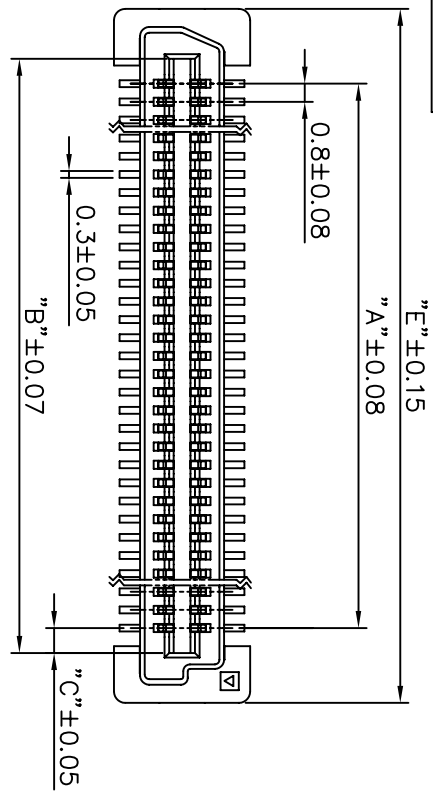


PRODUCT NO.
73277-XX1XXXXXX



SEC. Z-Z (2X)

NOTE: RECOMMENDED TRANSITION BOARD
THICKNESS IS 1.0 ± 0.05 MM

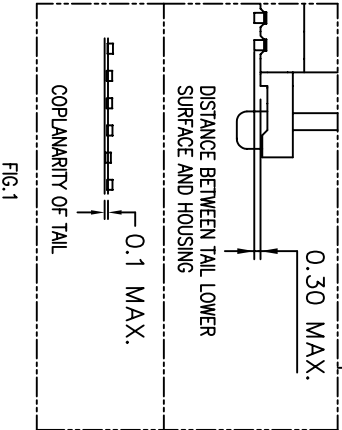


FIG.1

mat'l. code	ec'n no	dr	date	surface	tolerance	projection	product family
				ISO 1302	ISO 406 ISO 1101		BERGSTAK
				tolerances unless otherwise specified			
Itr				angles	± 0.38	mm	0.8mm BOARD TO BOARD
G	T03-0103	MW	4/3/03	linear	± 0.25	scale 1:1	MOD. RECEPTACLE ASS'Y
H	T03-0214	MW	06/10/03				
J	T03-0379	MW	08/04/03	0 ± 2	± 0.00		
K	T04-0094	MW	03/05/04	dr			
L	S04-0133	MW	06/24/04	engr	YU WEN CHU	8/18/00	
M	S04-0251	CH	11/23/04	chr	CHEN HONG	11/23/04	
N	S06-0196	MC	07/04/06	ppd	NG JOEY	11/23/04	
Sheet	revision	N	L				
index	sheet	1	2				



NUMBER OF POSITIONS	08	2 X 40	31.2	37.8	36.2	33.15	0.98
	10	2 X 50	39.2	45.8	44.2	41.4	1.1

"A"	"E"	"F"	"B"	"C"
-----	-----	-----	-----	-----

73277 - 1 1 1 1 1 1 1 1

	HOLD DOWN
0	NONE

COLOR	
NONE	BLACK, 16-659-012 OR 16-522-016
1	NATURAL, 16-522-015
LF (note 6)	BLACK, 16-659-012 OR 16-522-016 (For Lead Free Plating Option 4, 5 and 6)
1LF (note 6)	NATURAL, 16-522-015 (For Lead Free Plating Option 4, 5 and 6)

PLATING

0	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.2 umMIN. ON CONTACT AREA
1	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.1 umMIN OVER PALLADIUM-NICKEL ALLOY : 0.76umMIN ON CONTACT AREA
4	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.2 umMIN. ON CONTACT AREA SOLDER AREA PLATED PURE TIN 2.5um MIN.
5	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.38 umMIN ON CONTACT AREA SOLDER AREA PLATED PURE TIN 2.5um MIN.
6	NICKEL UNDERPLATE OVERALL 1.27 um MIN, GOLD PLATED: 0.1 umMIN OVER PALLADIUM-NICKEL ALLOY : 0.76umMIN ON CONTACT AREA SOLDER AREA PLATED PURE TIN 2.5um MIN.

PACKAGING

0	STICK
1	TAPE & REEL WITHOUT CAP
2	TAPE & REEL WITH CAP
9	STICK WITH CAP
8	TAPE & REEL WITH KAPTON

NOTES:

- 1.MATERIAL
HOUSING:G.F.LCP UL94V-0
COLOR: AS TABLE SHOWN.
TERMINAL: BERYLLIUM COPPER.
- 2.PLATING
AS TABLE SHOWN.
- 3.PACKAGING
SEE NO. GS-14-551 FOR PACKAGING SPECIFICATION.
- 4.SEE GS-12-148 FOR PRODUCT SPECIFICATION.
- 5.TAIL COPLANARITY
DISTANCE BETWEEN TAIL LOWER SURFACE AND HOUSING:SEE FIG.1.
COPLANARITY TO BE 0.1 MAX.
- 6 THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVE AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260 °C FOR 10 SECS IN A CONNECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN

mat'l. code		surface		tolerance		projection		product family	
litr	ecm no	dr	date	ISO 1302	ISO 406	ISO 1101		BERGSTAK	
K									
L	S06-0196	MC	07/04/06	angles	line of				
				0°±2'	.000±0.15	scale 1:1			
dr				MAGIE WU	B/18/00				
engr	YU WEN CHU	B/18/00							
chr	CHEN HONG	11/23/04							
pppd	NG JOEY	11/23/04							
sheet index	revision								



0.8mm BOARD TO BOARD MOD. RECEPTACLE ASS'Y

dwg no 73277 sheet 2 of 2 size A4

type Product Customer Drawing